# **Power MOSFET**

-20 V, -780 mA, Single P-Channel with ESD Protection, SOT-723

#### Features

- P-channel Switch with Low R<sub>DS(on)</sub>
- 44% Smaller Footprint and 38% Thinner than SC-89
- Low Threshold Levels Allowing 1.5 V R<sub>DS(on)</sub> Rating
- Operated at Low Logic Level Gate Drive
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### Applications

- Load/Power Switching
- Interfacing, Logic Switching
- Battery Management for Ultra Small Portable Electronics

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise stated)

( 0			'			
Parameter		Symbol	Value	Unit		
Drain-to-Source Voltage		V <sub>DSS</sub>	-20	V		
Gate-to-Source Voltage		V <sub>GS</sub>	± 6	V		
Continuous Drain	Steady	$T_A = 25^{\circ}C$	Ι <sub>D</sub>	-780	mA	
Current (Note 1)	State	T <sub>A</sub> = 85°C		-570		
	$t \le 5 s$	$T_A = 25^{\circ}C$		-870		
Power Dissipation (Note 1)	Steady State	$T_A = 25^{\circ}C$	P <sub>D</sub>	450	mW	
	$t \le 5 s$			550		
Continuous Drain	Steady	T <sub>A</sub> = 25°C	Ι <sub>D</sub>	-660	mA	
Current (Note 2)	State	$T_A = 85^{\circ}C$		-480		
Power Dissipation (Note 2)		$T_A = 25^{\circ}C$	P <sub>D</sub>	310	mW	
Pulsed Drain Cur- rent	t <sub>p</sub> = 10 μs		I <sub>DM</sub>	-1.2	A	
Operating Junction and Storage Tempera- ture		T <sub>J</sub> , T <sub>STG</sub>	–55 to 150	°C		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C		

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces)

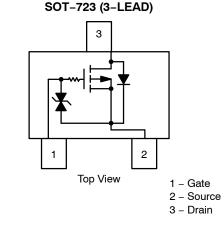
2. Surface mounted on FR4 board using the minimum recommended pad size

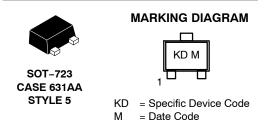


## **ON Semiconductor®**

#### http://onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> TYP	I <sub>D</sub> Max		
-20 V	0.38 Ω @ -4.5 V	–780 mA		
	0.52 Ω @ −2.5 V	–660 mA		
	0.70 Ω @ –1.8 V	–100 mA		
	0.95 Ω @ –1.5 V	–100 mA		





#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>	
NTK3139PT1G		4000 / Tape & Reel	
NTK3139PT1H	SOT-723	40007 Tape & neer	
NTK3139PT5G	Pb-Free	8000 / Tape & Reel	
NTK3139PT5H		8000 / Tape & Hee	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

#### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Unit
Junction-to-Ambient - Steady State (Note 3)	$R_{ hetaJA}$	280	°C/W
Junction-to-Ambient - t = 5 s (Note 3)	$R_{ hetaJA}$	228	
Junction-to-Ambient - Steady State Minimum Pad (Note 4)	$R_{ hetaJA}$	400	

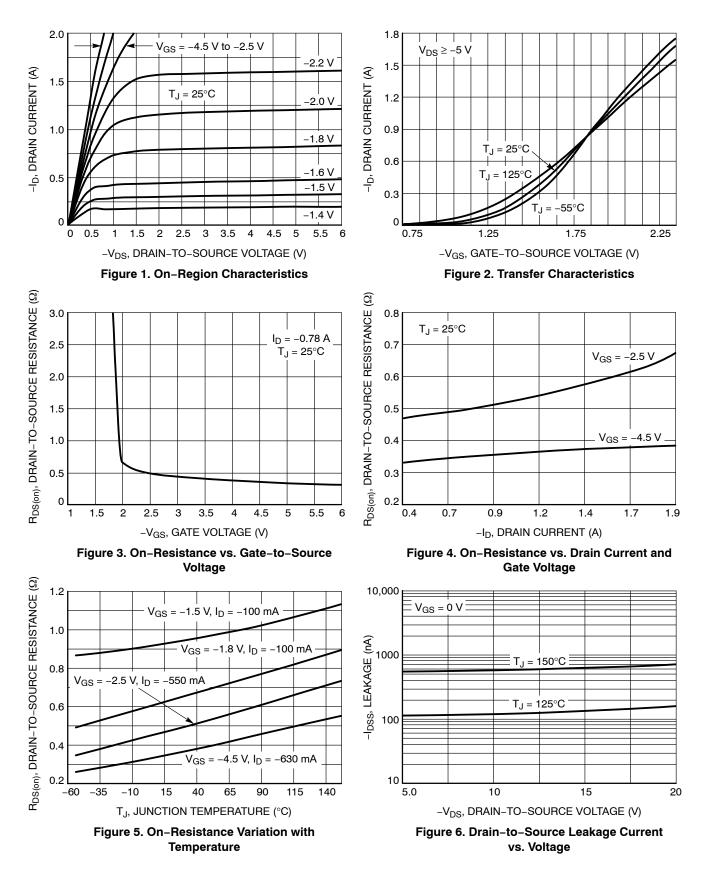
Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces)
Surface mounted on FR4 board using the minimum recommended pad size

### MOSEET ELECTRICAL CHARACTERISTICS (T. - 25°C unless otherwise specified)

Parameter	Symbol	Test Condition	<u></u> ו	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = -25	$V_{GS}$ = 0 V, $I_D$ = -250 $\mu$ A				V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>	I <sub>D</sub> = −250 μA, Reference	$I_D = -250 \ \mu$ A, Reference to 25°C		-16.5		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = -16V	$T_J = 25^{\circ}C$			-1.0	μΑ
			T <sub>J</sub> = 125°C			-2.0	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±4.5 V				±2.0	μΑ
ON CHARACTERISTICS (Note 5)	•						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}$ , $I_D = -250 \ \mu A$		-0.45		-1.2	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				2.4		mV/°C
Drain-to-Source On Resistance		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -780 \text{ mA}$			0.38	0.48	Ω
	_	$V_{GS}$ = -2.5 V, I <sub>D</sub> = -660 mA			0.52	0.67	
	R <sub>DS(on)</sub>	$V_{GS} = -1.8 \text{ V}, \text{ I}_{D} = -100 \text{ mA}$			0.70	0.95	
		$V_{GS}$ = -1.5 V, I <sub>D</sub> = -100 mA			0.95	2.20	
Forward Transconductance	9 <sub>FS</sub>	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -540 \text{ mA}$			1.2		S
CHARGES, CAPACITANCES AND (	GATE RESISTAN	ICE					
Input Capacitance	C <sub>ISS</sub>				113	170	
Output Capacitance	C <sub>OSS</sub>	$V_{GS}$ = 0 V, f = 1 MHz, $V_{DS}$ = –16 V			15	25	pF
Reverse Transfer Capacitance	C <sub>RSS</sub>				9.0	15	
SWITCHING CHARACTERISTICS, V	/ <sub>GS</sub> = 4.5 V (Note	e 6)					
Turn On Delay Time	t <sub>d(ON)</sub>	$V_{GS}$ = -4.5 V, $V_{DS}$ = -10 V, I <sub>D</sub> = -200 mA, R <sub>G</sub> = 10 Ω			9.0		- ns
Rise Time	tr				5.8		
TurnOff Delay Time	t <sub>d(OFF)</sub>				32.7		
Fall Time	t <sub>f</sub>				20.3		
DRAIN SOURCE DIODE CHARACT	ERISTICS						
Forward Diode Voltage	V <sub>SD</sub>	$V_{GS}$ = 0 V, I <sub>S</sub> = -350 mA	$T_J = 25^{\circ}C$		-0.8	-1.2	V
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, d <sub>ISD</sub> /d <sub>t</sub> = 100 A/µs, I <sub>S</sub> = -1.0 A, V <sub>DD</sub> = -20 V			13.2		ns
Charge Time	t <sub>a</sub>				11.8		1
Discharge Time	t <sub>b</sub>				1.4		1
Reverse Recovery Charge	Q <sub>RR</sub>				5.0		nC

5. Pulse Test: pulse width = 300  $\mu$ s, duty cycle = 2% 6. Switching characteristics are independent of operating junction temperatures

#### **TYPICAL CHARACTERISTICS**



### **TYPICAL CHARACTERISTICS**

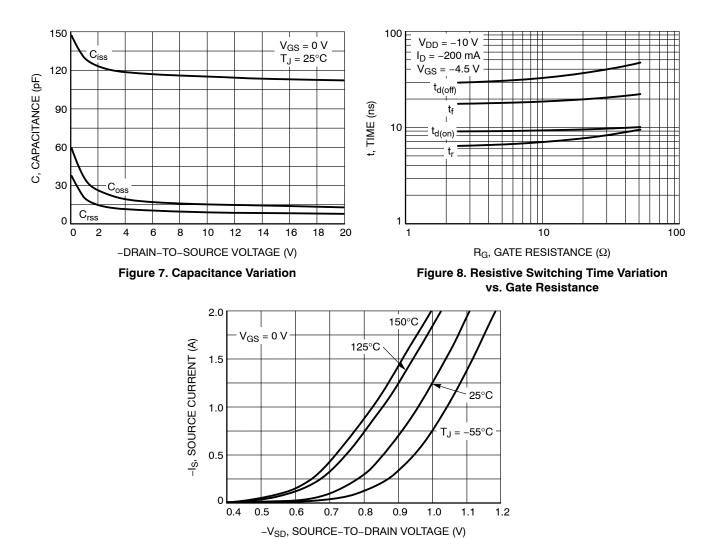
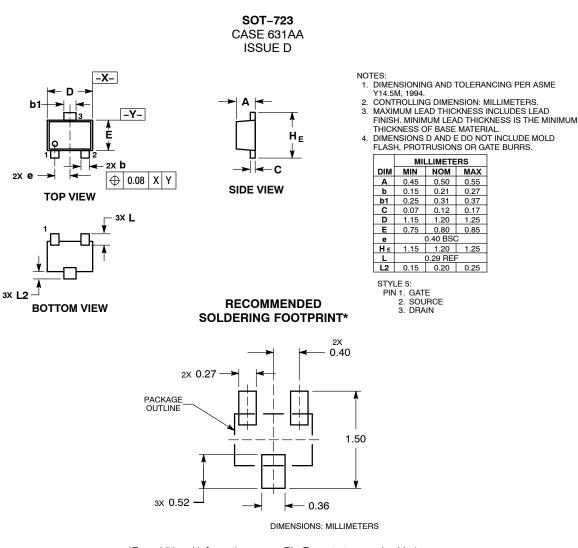


Figure 9. Diode Forward Voltage vs. Current

#### PACKAGE DIMENSIONS



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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